PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Takashi NIWA	05/10/2013
Matsuo KISHI	05/10/2013
Koichiro JUJO	05/10/2013
Hiroyuki HOSHINA	05/10/2013

RECEIVING PARTY DATA

Name:	SEIKO INSTRUMENTS INC.
Street Address:	8 Nakase, 1-Chome
Internal Address:	Mihama-ku
City:	Chiba-shi
State/Country:	JAPAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13897861

CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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ATTORNEY DOCKET NUMBER:	SIP039DIV
NAME OF SUBMITTER:	Paul J. Kroon, Jr.
Signature:	/Paul J. Kroon, Jr./

502354144 REEL: 030453 FRAME: 0382

OP \$40.00 13897861

Date:	05/21/2013
Total Attachments: 3 source=SIP039DIV_ASSIGNMENT#page1. source=SIP039DIV_ASSIGNMENT#page2. source=SIP039DIV_ASSIGNMENT#page3.	tif

PATENT REEL: 030453 FRAME: 0383 WHEREAS, I/We, Takashi NIWA, Matsuo KISHI, Koichiro JUJO and Hiroyuki

HOSHINA made certain new and useful inventions and improvements for which I/We filed, or

will be filing, an application for Letters Patent of the United States, identified as U.S. patent

application serial number 13/897,861 filed on May 20, 2013, which application is entitled:

METHOD OF MANUFACTURING ELECTROFORMING MOLD, ELECTROFORMING MOLD, AND METHOD OF MANUFACTURING

ELECTROFORMED COMPONENT

AND, WHEREAS, I/We hereby authorize and request an attorney associated with

Customer Number 32047 to insert on the designated lines above, the filing date and application

number of said application when known;

AND, WHEREAS, SEIKO INSTRUMENTS INC. corporation organized and existing

under and by virtue of the laws of Japan, and having an office and place of business at 8 Nakase

1-Chome, Mihama-ku, Chiba-shi, Japan, (hereinafter "Assignee"), is desirous of acquiring the

entire right, title and interest in and to said inventions, improvements and application and in and

to the Letters Patent to be obtained therefore;

NOW, THEREFORE, to all whom it may concern, be it known that for good and

valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I/We have

sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said

Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all

inventions and improvements disclosed in the aforesaid application, and in and to the said

application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters

Patent which may be granted there from, and all reissues or extensions of such patents, and in

and to any and all applications which have been or shall be filed under the Patent Cooperation

Treaty, in any regional patent offices and in any foreign countries for Letters Patent on the said

PATENT

REEL: 030453 FRAME: 0384

inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and I/We do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letter Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, I/We do hereby agree that I/We and my/our executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to me/us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be;

AND, furthermore, I/We covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me/us and that full right to convey the same as herein expressed is possessed by me/us.

AND, as a named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application, including the claims, and I am aware of the duty to disclose to the Office all information known to the person to be material to patentability as defined in 37 C.F.R. § 1.56.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN TESTIMONY WHEREOF, I have hereunto set my hand this 10 day of May 2013
Takony Ning
Takashi NIWA
IN TESTIMONY WHEREOF, I have hereunto set my hand this 10 day of May, 2013.
Matano Kishi
Matsuo KISHI
IN TESTIMONY WHEREOF, I have hereunto set my hand this 10 day of May , 2013.
Koichira Jujo
Koichiro JUJO
IN TESTIMONY WHEREOF, I have hereunto set my hand this 10 day of May , 2013.
Hirozaki Hoshina
Hiroyuki HOSHINA

PATENT REEL: 030453 FRAME: 0386

RECORDED: 05/21/2013